AN5633K

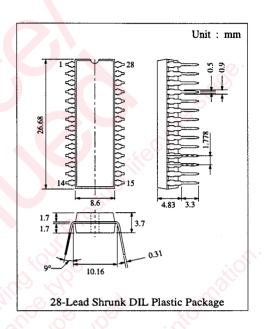
SECAM-PAL Signal Conversion Circuit

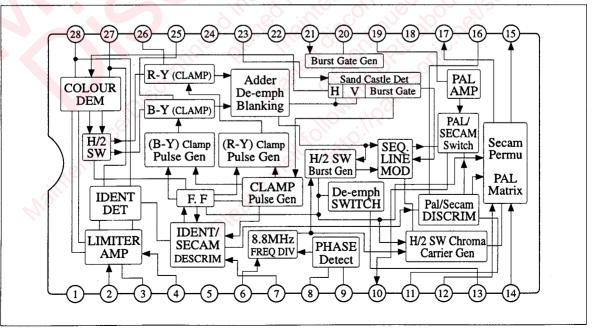
Description

The AN5633K is an integrated circuit designed for conversion from SECAM Colour TV Signal to Pseudo PAL modulated in line sequential orthogonal two-phase width. Suitable combination with AN5601K.

Features

- Reduction of line crawling by line sequential detection (12dB as compared with the conventional one)
- SECAM/PAL discriminating capability is improved by detecting colour killer voltage of PAL demodulation IC
- Reduced number of peripheral units like transformer and adjustment processes





Block Diagram

■ Absolute Maximum Ratings (Ta=25°C)

	Item		Rat	ting	Unit
Supply Voltage		Vcc	14.4		v
Supply Current		I _{CC}	82.7		mA
		V 2, 4, 11, 13, 16, 22, 23	0	V ₁₈₋₁	v
Voltage		V 5	0	6	v
vonage		V 6	0	8	v
		V 12, 14, 19	0	7	v
		I ₈	-1	0	mA
Current		I g I	-3	0	mA
Current		I 13	0	10	mA
		I _{20, 21}	-0.05	2	mA
Power Dissipation		PD	1142		mW
Temperature	Operating Ambient Temperature	Topr	-20 ~ +70		°C
	Storage Temperature	Tstg	-55 ~	+150	°C

■ Recommended Operating Range (Ta=25°C)

Item	Symbol	Range
Operating Supply Voltage Range	Vcc	9.6V ~ 14.4 V

■ Electrical Characteristics (Ta=25°C)

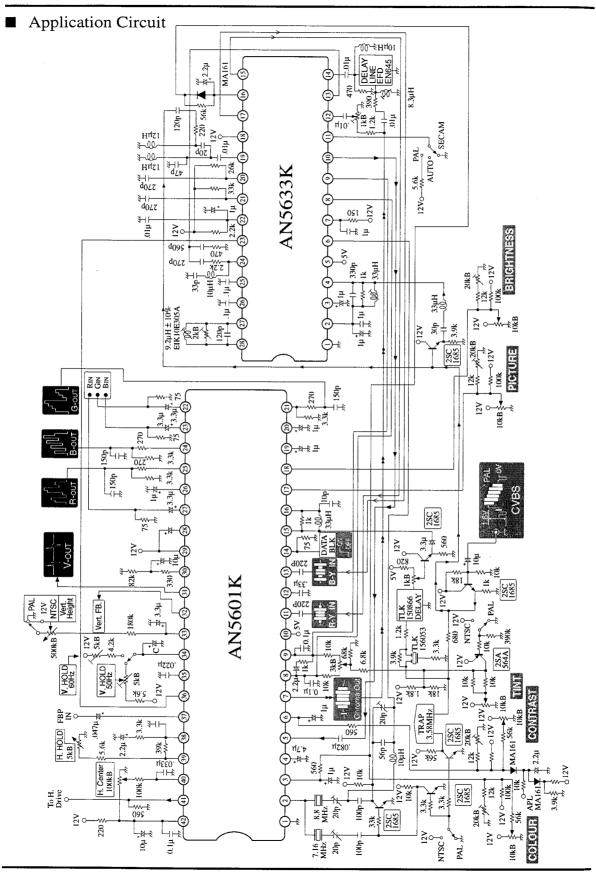
Item Symbol		Condition		typ.	max.	Unit
DC Section						, k
Circuit Current 12V	I_{CC1} $V_{CC1} = 12V, V_{CC2} = 5V$		37	50	63	mA
Circuit Current 5V	I _{CC2}	$V_{CC1} = 12V, V_{CC2} = 5V$		13	16	mA
AC Section						
Chroma Section						
SECAM Input Signal Limiting	V _{O (lim)}	4.433168MHz Input of Pin 4, 10 ~ 300mVpp Output of Pin 28	-1	0	1	dB
Limiter Amp. Gain Gv (lin		Ratio of 4.433168MHz Input of Pin 4 to 1mVpp output of Pin 28	28	32	36	dB
SECAM Demodulator Colour Diiference Ratio (B-Y/R-Y) B-Y/R-Y		SECAM Colour Bar input of Pin 4 : 200mVpp, Ratio of B of DB to R of DR of Pin 24 when the white levels of DB and DR of Pin 24 are matched	0.67 0.74		0.81	Times
SECAM Output Signal Voltage	CO(SECAM)	SECAM Colour Bar input of Pin 4 : 200mVpp R of Output DR of Pin 24 when the white levels of DB and DR of Pin 24 are matched	60	180	300	mVpp
Ratio of Burst to Chroma $\frac{e_{O(s)}}{e_{O(s)}}$		SECAM Colour Bar input of Pin 4 : 200mVpp Ratio of burst to R of output DR of Pin 24 when the white levels of DB and DR of Pin 24 are matched	1.8	2.6	3.4	Times
PAL Input Signal Voltage	Vi(PAL)	PAL input signal of Pin 19			1100	mVpp
PAL Output Signal Voltage	eo(pal)	PAL input of Pin 19 : 750mVpp, Output of Pin 10		620	750	mVpp
Discrimination Section						•

Killer Tolerance	ek	Killer On level to SECAM Colour Bar input of Pin 4 : 0dB (100mVpp)	-38	-31	-24	dB
Killer Detection Voltage SECAM Colour	V11-1(SECAM)	Voltage of Pin 11 when SECAM Colour Bar input of Pin 4 is -7dB	0	0.25	0.5	v
Killer Detection Voltage SECAM OFF	V _{11-1(OFF)}	Voltage of Pin 11 when SECAM Colour Bar input of Pin 4 is -43dB	0.5	1.3	2.1	v

Panasonic

Item	Symbol	Condition	min.	typ.	max.	Unit
Discrimination Section (Cor	ntinue)					
Ident Detection Voltage PAL	V11-1 PAL	Voltage of Pin11 when PAL Colour Bar input burst of Pin 4 is 150mVpp	0.5	1.3	2.1	v
Pulse Input						
BLK Detection Voltage	V _{BLK}	Blanking pulse input voltage range of Pin 23	1	1.5	2	v
H Pulse Detection Voltage	V _H	H pulse input voltage range of Pin 23	3	3.5	4	v
Burst Gate Pulse Det. Voltage	V _{BGP}	Burst gate pulse input voltage range of Pin 23	6.5	7	7.5	v
Burst Phase Width Adjustm	ent Section	l				
Comparator Threshold Level	V _{21LH}	Voltage of Pin 20 at which L is changed to H when $3k\Omega$ Vcc of Pin 20 and 100 μ A of Pin 21 are applied	2.6	3.1	3.6	v
SECAM Switch PAL Matri	x					
PAL Amplification	A _{PAL}	Gain of Pin 12 to Pin 15 input in case of SECAM	0.9	1.1	1.3	Times
PAL Amplification Error	ΔA_{PAL}	Error between gain of Pin 12 input to Pin 15 and gain of Pin 14 input to Pin 15 output	0	5	10	%
SECAM Amplification	Asecam	Gain of Pin 12 to Pin 15 output in case of PAL	1.8	2.2	2.6	Times
De-emphasis Switch						
De-emphasis Swtich Output DR	V _{13-1 DR}	Pin 13 output is Vcc1=12V when SECAM Colour Bar DR of Pin 4 is input	11	12	13	v
De-emphasis Switch Output DB	V _{13-1 DB}	Pin 13 output is Vcc1=12V when SECAM Colour Bar DB of Pin 4 is input	0	0.25	0.5	v

AN5633K



Panasonic

Pin No.	Pin Name	Pin Description	Typical Waveform	Equivalent Circuit
1	GND	GND Pin		2quination chour
2	Limiter Feedback	Filter Pin for keeping DC balance of limiter circuit	1	
3				
4	SECAM Signal Input	SECAM Input pin PAL Signal after input is separated at the latter Ident section and the switch selection according to PAL is made	Pin 4 Signal	(4) - 330 11k 0 0.2mA
5	Power Supply (5V)	5V Power Pin		
6	8.8MHz CW Input	Input 8.8MHz of the AN5601K		
7	System Discrimination Hold Capacitance	Filter pin for holding the result discriminated by the system at the Ident section		12V 0 1.5mAl 10k
8	Phase Detection	Pin for inputting the result of chroma carrier phase of Pseudo PAL signal		390 150 0 12V
9		disciminated by the AN5601K Proper phase is given by the entire system		
10	Output (PAL/Pseudo PAL)	Pin for output signal which was converted into the Pseudo PAL signal of SECAM	Pin 10 Signal	

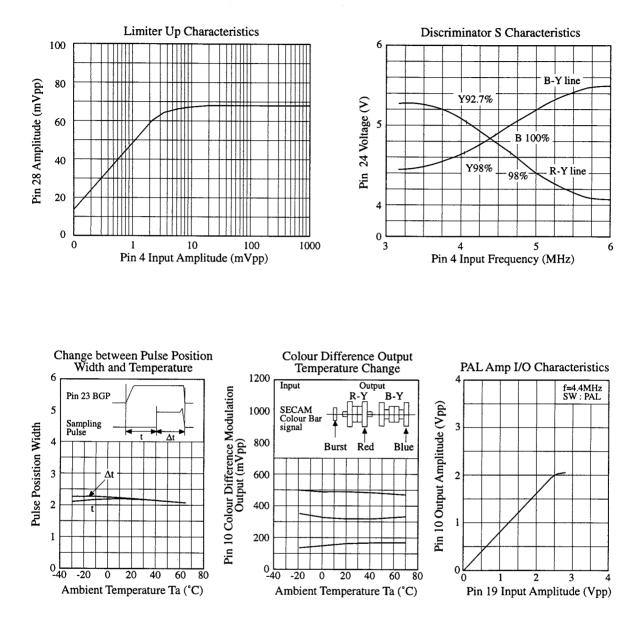
AN5633K

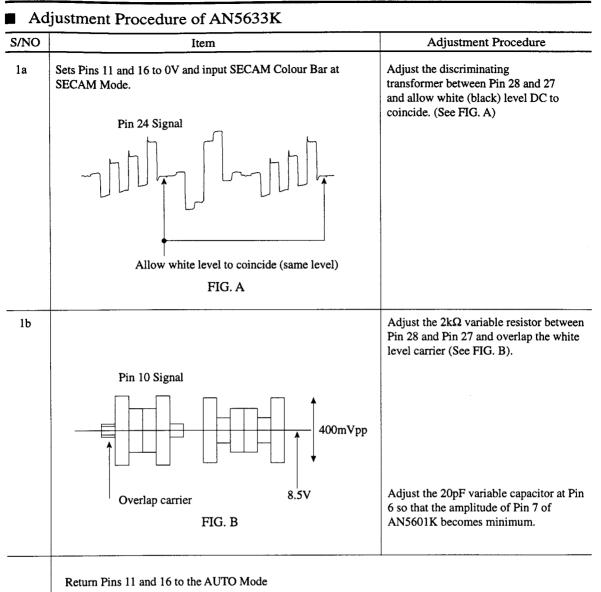
'in No.	Pin Name	Pin Description	Typical Waveform	Equivalent Circuit	
11	System Discriminating Switch	Output pin for determining that the signal input to Pin 4 is PAL or SECAM. It also has the function to switch the internal system manually			
12	Direct Signal Input	Pin for signal which is directly input to the PAL matrix in case of PAL and to the permutator circuit in case of SECAM. Connect to the ACC output pin of the AN5601K	Pin 12 Signal	12 430 430 430 430 430 1.2mA 430 430 1.2mA	
13	De-emphasis Switch	Pin for switching the filter for de-emphasizing Pin 24	64µs 64µs		
14	Delay Signal Input	Pin for 1-H delayed signal which is input to the PAL matrix in case of PAL and to the permutator circuit in case of SECAM	Pin 14 Signal Pin 14 Signal DC DC 2.9V (Pseudo PAL)	(14) (14) (14) (14) (14) (12) (12) (12) (12) (12) (12) (12) (12	
15	R-Y Signal Output	Continuous modulation R-Y signal output pin	Pin 15 Signal	12V Ø 100 222 2.2k	
17	B-Y Signal Output	Continuous modulation B-Y signal output pin	Pin 17 Signal	(15) 17 18k	
16	PAL Colour Killer Discrimination Input	Pin for inputting colour killer discriminating voltage of the AN5601K The PAL/SECAM discriminating capability is increased by the internal logic circuit			

Pin No.	Pin Name	Pin Description	Typical Waveform	Equivalent Circuit
18	Power Supply (12V)	12V Power Pin		
19	PAL Signal Input	Signal together with Pin 4 input, is output directly from Pin 19 to Pin 10 in case of PAL	Pin 19 Signal	19 300 900 3.3k 1.5mA 0 0.3mA 0
20	Burst Gate Pulse Fall Setting	Pin for setting the falling point of internal burst sampling pulse		
21	Burst Gate Pulse Rise Setting	Pin for setting the rising point of internal burst sampling pulse		
22	Reference Bias Voltage	Filter pin for applying noise-free reference voltage to the internal circuit		22 22 22 22 22 27 External of IC
23	Pulse Signal Input	Pin for taking in Sand castle pulse of the AN5601K	Burst Gate HBLK	
24	De-emphasis	Pin for de-emphasizing a signal to which SECAM signal is demodulated in line-sequence		
25	B-Y Clamping Capacitance	Clamping Capacitor pin for regenerating DC voltage in B-Y for Pin 25, R-Y for		
26	R-Y Clamping Capacitance	Pin 26 line in which SECAM signal is demodulated in line- sequence		
27	Discriminator	Discriminator Pin for SECAM demodulation R.L.C. parallel		
28		resonator is externally connected		

Supplementary Explanation

Characteristic Curve Diagrams





Pin 11 in AUTO	SECAM Colour	0V	Automatically given in the AN5633K	
FIII II III AOIO	Other	~ 1V	Automatically given in the AN305.	
	PAL Colour	1.5V or more	Given from the AN5601K	
Pin 16 in AUTO	PAL Killer	0V		

Request for your special attention and precautions in using the technical information and semiconductors described in this book

- (1) If any of the products or technical information described in this book is to be exported or provided to non-residents, the laws and regulations of the exporting country, especially, those with regard to security export control, must be observed.
- (2) The technical information described in this book is intended only to show the main characteristics and application circuit examples of the products. No license is granted in and to any intellectual property right or other right owned by Panasonic Corporation or any other company. Therefore, no responsibility is assumed by our company as to the infringement upon any such right owned by any other company which may arise as a result of the use of technical information described in this book.
- (3) The products described in this book are intended to be used for standard applications or general electronic equipment (such as office equipment, communications equipment, measuring instruments and household appliances).
 - Consult our sales staff in advance for information on the following applications:
 - Special applications (such as for airplanes, aerospace, automobiles, traffic control equipment, combustion equipment, life support systems and safety devices) in which exceptional quality and reliability are required, or if the failure or malfunction of the products may directly jeopardize life or harm the human body.
 - Any applications other than the standard applications intended.
- (4) The products and product specifications described in this book are subject to change without notice for modification and/or improvement. At the final stage of your design, purchasing, or use of the products, therefore, ask for the most up-to-date Product Standards in advance to make sure that the latest specifications satisfy your requirements.
- (5) When designing your equipment, comply with the range of absolute maximum rating and the guaranteed operating conditions (operating power supply voltage and operating environment etc.). Especially, please be careful not to exceed the range of absolute maximum rating on the transient state, such as power-on, power-off and mode-switching. Otherwise, we will not be liable for any defect which may arise later in your equipment.

Even when the products are used within the guaranteed values, take into the consideration of incidence of break down and failure mode, possible to occur to semiconductor products. Measures on the systems such as redundant design, arresting the spread of fire or preventing glitch are recommended in order to prevent physical injury, fire, social damages, for example, by using the products.

- (6) Comply with the instructions for use in order to prevent breakdown and characteristics change due to external factors (ESD, EOS, thermal stress and mechanical stress) at the time of handling, mounting or at customer's process. When using products for which damp-proof packing is required, satisfy the conditions, such as shelf life and the elapsed time since first opening the packages.
- (7) This book may be not reprinted or reproduced whether wholly or partially, without the prior written permission of our company.

20080805